# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
YONG LIU	08/15/2011

# **RECEIVING PARTY DATA**

Name:	ne: FAIRCHILD SEMICONDUCTOR CORPORATION	
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City:	SUNNYVALE	
State/Country:	CALIFORNIA	
Postal Code:	94089	

# **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	13171577

# **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	2921.430USA
NAME OF SUBMITTER:	KATY NOON
SIGNATURE:	/Katy Noon/
DATE SIGNED:	07/26/2016

# **Total Attachments: 2**

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**PATENT** REEL: 039268 FRAME: 0877 503933452

Application No.: 13/171,577 Attorney Docket No.: 73300/11948.129

# ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, the person(s) named below (referred to as "INVENTOR" whether singular or plural) has sold, assigned, and transferred and does hereby sell, assign, and transfer to <u>Fairchild Semiconductor Corporation</u>, having a place of business at 3030 Orchard Parkway, San Jose, CA 95134 ("ASSIGNEE"), for itself and its successors, transferees, and assignees, the following:

1.	("SUB Letters	ntire worldwide right, title, and interest in all inventions and improvements JECT MATTER") that are disclosed in the application for United States a Patent entitled: Wafer Level Embedded and Stacked Die Power System-kage Packages ("APPLICATION"), which:
		is to be filed herewith (attorney docket no. <u>73300/11948.129</u> ) was filed on 06/29/2011 now bearing U.S. Serial No.:13/171,577)
	and	

2. The entire worldwide right, title, and interest in and to:

(a) the APPLICATION, including any right of priority; (b) any divisional, continuation, substitute, renewal, reissue, and other related applications which have been or may be filed in the United States or elsewhere in the world; and (c) any patents which may be granted on the applications set forth in (a) and (b) above.

INVENTOR agrees that ASSIGNEE may apply for and receive patents for SUBJECT MATTER in ASSIGNEE's own name.

INVENTOR agrees to do the following, when requested, and without further consideration, in order to carry out the intent of this Assignment: (1) execute all oaths, assignments, powers of attorney, applications, and other papers necessary or desirable to fully secure to ASSIGNEE the rights, titles and interests herein conveyed; (2) communicate to ASSIGNEE all known facts relating to the SUBJECT MATTER; and (3) generally do all lawful acts that ASSIGNEE shall consider desirable for securing, maintaining, and enforcing worldwide patent protection relating to the SUBJECT MATTER and for vesting in ASSIGNEE the rights, titles, and interests herein conveyed. INVENTOR further agrees to provide any successor, assign, or legal representative of ASSIGNEE with the benefits and assistance provided to ASSIGNEE hereunder.

INVENTOR represents that INVENTOR has the right, title, and interests to convey as set forth herein, and covenants with ASSIGNEE that the INVENTOR has made or will make hereafter no assignment, grant, mortgage, license, or other agreement affecting the rights, titles, and interests herein conveyed.

This Assignment may be executed in one or more counterparts, each of which shall be deemed an original and all of which may be taken together as one and the same Assignment.

Application No.: 13/171,577 Attorney Docket No.: 73300/11948.129

ASSIGNOR:
Jong Liu Date 08/15/2011
COUNTRY OF USA
BEFORE ME, the undersigned authority, on this day of, 2011, personally appeared <u>Yong Liu</u> , personally known or proven by satisfactory documentary evidence to me to be the person whose name is subscribed to the foregoing instrument and acknowledged to me that he executed the same of his own free will for the purposes and consideration therein expressed.
Notary Public